

# HV6810

## **10-Channel Serial-Input Latched Display Driver**

#### Features

- High Output Voltage 80V
- High-speed 5 MHz at 5 V<sub>DD</sub>
- Low-power I<sub>BB</sub> ≤ 0.1 mA (All High)
- Active Pull-down 100 µA Minimum at 25°C
- Output Source Current 25 mA at 60V V<sub>BB</sub>
- 10-channel Display Driver
- High-speed Serially-shifted Data Input
- 5V CMOS-compatible Inputs
- · Latches on all Driver Outputs
- Pin-compatible Replacement for UCN5810A, TL4810A and TL4810B

#### Applications

- · High-speed Dot Matrix Print Head Driver
- · Vacuum Fluorescent Display (VFD) Driver

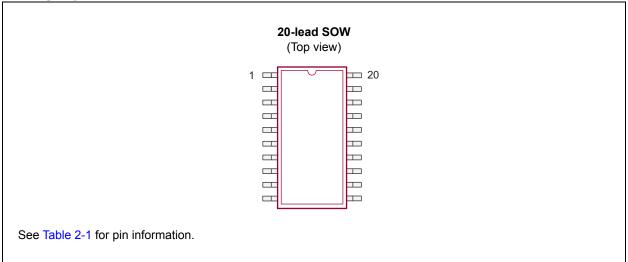
#### **General Description**

The HV6810 is a monolithic integrated circuit designed to drive a dot matrix or segmented VFD. These devices feature a serial data output to cascade additional devices for large displays.

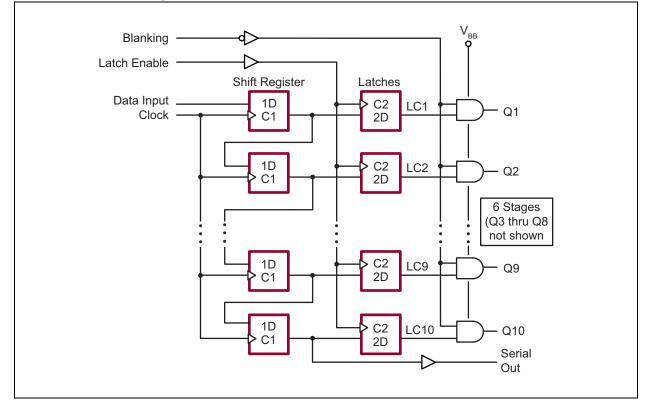
A 10-bit data word is serially loaded into the shift register on the positive-going transition of the clock. Parallel data are transferred to the output buffers through a 10-bit D-type latch while the latch enable input is high. The data are latched when the latch enable is low. When the blanking input is high, all of the outputs are low.

Outputs are structures formed by double-diffused MOS (DMOS) transistors with output voltage ratings of 80V and 25 mA source-current capability. All inputs are compatible with CMOS levels.

#### Package Type



#### **Functional Block Diagram**



### 1.0 ELECTRICAL CHARACTERISTICS

#### Absolute Maximum Ratings† (Note 1)

Logic Supply Voltage, V <sub>DD</sub> (Note 2)	
Driver Supply Voltage, V <sub>BB</sub> (Note 2)	
Output Voltage (Note 2)	
Input Voltage (Note 2)	–0.3V to V <sub>DD</sub> +0.3V
Operating Ambient Temperature, T <sub>A</sub>	–45°C to +85°C
Continuous Total Power Dissipation at 25°C Free-air Temperature:	
20-lead SOW (Note 3)	1500 mW

**† Notice:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

Note 1: Over operating free-air temperature

- 2: All voltages are referenced to V<sub>SS</sub>.
- 3: For operations above 25°C ambient, derate linearly to 85°C at 15 mW/°C.

#### **RECOMMENDED OPERATING CONDITIONS**

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions
Logic Supply Voltage	V <sub>DD</sub>	4.5	—	5.5	V	
High Supply Voltage	V <sub>BB</sub>	20	—	80	V	
Supply Voltage	V <sub>SS</sub>	_	0		V	
High-level Input Voltage (for V <sub>DD</sub> = 5V)	V <sub>IH</sub>	3.5	_	5.3	V	
Low-level Input Voltage	V <sub>IL</sub>	-0.3	_	0.8	V	
Continuous High-level Q Output Current	I <sub>ОН</sub>	25	_	_	mA	
Clock Frequency	f <sub>CLK</sub>	-	—	5	MHz	
Operating Ambient Temperature	T <sub>A</sub>	-40	_	+85	°C	

## DC ELECTRICAL CHARACTERISTICS

<b>Electrical Specifications:</b> $V_{DD}$ = 5V, $V_{BB}$ = 60V, $V_{SS}$ = 0V and $T_A$ = 25°C unless otherwise noted.											
Paramete	er	Sym.	Min.	Тур.	Мах	Unit	Conditions				
High-level Output	Q Outputs	V	57.5	58	—	V	I <sub>O</sub> = +25 mA				
Voltage	Serial Output	V <sub>OH</sub>	4	4.5	—	v	$V_{DD}$ = +4.5V, $I_{OL}$ = +100 µA				
Low-level Output	Q Outputs	V <sub>OL</sub>		0.15	1	V	I <sub>O</sub> = –100 μA, blanking input at V <sub>DD</sub>				
Voltage	Serial Output	-	_	0.05	0.1		V <sub>DD</sub> = +4.5V, I <sub>O</sub> = -100 μA				
Low-level Q Output Cur (Pull-down Current)	rent	I <sub>OL</sub>	60	80	_	μA	T <sub>A</sub> = Max, V <sub>OL</sub> = +0.7V (Note 1)				
Off-state Output Curren	t	I <sub>O(OFF)</sub>	_	-1	-15	μA	V <sub>O</sub> = 0V, blanking input at V <sub>DD</sub> ( <b>Note 1</b> )				
High-level Input Current	t	I <sub>IH</sub>	_	—	1	μA	V <sub>IN</sub> = V <sub>DD</sub>				
Supply Current from V	(Standby)		_	10	50		All inputs at 0V, one Q output high				
Supply Current from V <sub>D</sub>	D (Stanuby)	I <sub>DD</sub>	_	10	50	μA	All inputs at 0V, all Q outputs low				

**Note 1:** All typical values are at  $T_A = 25^{\circ}C$  except for  $I_{OL}$  and  $I_{O(OFF)}$ .

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## DC ELECTRICAL CHARACTERISTICS (CONTINUED)

<b>Electrical Specifications:</b> $V_{DD}$ = 5V, $V_{BB}$ = 60V, $V_{SS}$ = 0V and $T_A$ = 25°C unless otherwise noted.										
Parameter	Sym.	Min.	Тур.	Мах	Unit	Conditions				
Supply Current from V	-		0.05	0.1	mA	All outputs low, all Q outputs open				
Supply Current from V <sub>BB</sub>	IBB	_	0.05	0.1		All outputs high, all Q outputs open				

**Note 1:** All typical values are at  $T_A = 25^{\circ}C$  except for  $I_{OL}$  and  $I_{O(OFF)}$ .

## AC ELECTRICAL CHARACTERISTICS

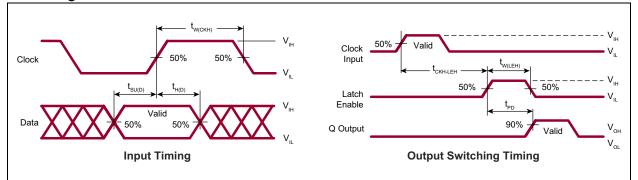
Electrical Specifications: Timing requirements are over the recommended operating conditions.										
Parameter	Sym.	Min.	Тур.	Max	Unit	Conditions				
Pulse Duration, Clock High	t <sub>W(CKH)</sub>	100	—	_	ns					
Pulse Duration, Latch Enable High	t <sub>W(LEH)</sub>	100	—	_	ns					
Setup Time, Data before Clock	t <sub>SU(D)</sub>	50	—	_	ns					
Hold Time, Data after Clock	t <sub>H(D)</sub>	50	—	_	ns					
Delay Time, Clock to Latch Enable High	t <sub>CKH-LEH</sub>	50	_	_	ns					
Propagation Delay Time, Latch Enable to Output	t <sub>PD</sub>	_	300	_	ns	Note 1				

**Note 1:** Switching characteristics,  $V_{BB} = 60V$ ,  $T_A = 25^{\circ}C$ 

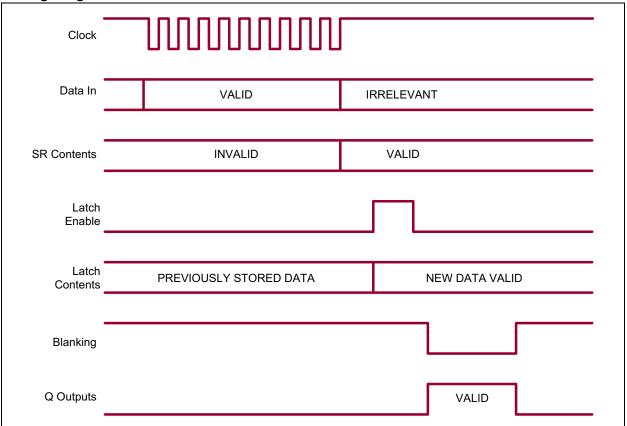
#### TEMPERATURE SPECIFICATIONS

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions					
TEMPERATURE RANGE											
Operating Ambient Temperature	T <sub>A</sub>	-40	_	+85	°C						
PACKAGE THERMAL RESISTANCE											
20-lead SOW	$\theta_{JA}$		66	_	°C/W						

#### **Switching Waveforms**



#### **Timing Diagram**



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#### 2.0 PIN DESCRIPTION

The details on the pins of HV6810 are listed on Table 2-1. Refer to **Package Type** for the location of pins.

Pin Number	Pin Name	Description					
1	Q8						
2	Q7	High-voltage output					
3	Q6						
4	CLOCK	Input data are shifted into the data shift register on the positive edge of the clock.					
5	VSS	Usually V <sub>SS</sub> = 0V; ground connection					
6	N/C	lo connection					
7	VDD	Low-voltage power supply					
8	LE (STROBE)	When LE is high, the shift register output is latched to Q output. When LE stays high, the latches are in Transparent mode.					
9	Q5						
10	Q4						
11	Q3	High-voltage output					
12	Q2						
13	Q1						
14	BLANKING	When blanking is high, all Q's are forced to a Low state regardless of data in each channel.					
15	DATA IN	Input data for the input shift register					
16	VBB	High-voltage power supply					
17	SERIAL DATA OUT	Output data from the shift register					
18	N/C	No connection					
19	Q10						
20	Q9	High-voltage output					

#### TABLE 2-1: PIN FUNCTION TABLE

#### 3.0 FUNCTIONAL DESCRIPTION

Follow the steps below to power up and power down the HV6810.

### POWER-UP AND POWER-DOWN SEQUENCE<sup>1</sup>

	Power-up	Power-down					
Step	Description	Step	Description				
1	Connect ground V <sub>SS</sub> .	1	Remove V <sub>BB</sub> .				
2	Apply V <sub>DD</sub> .	2	Remove all inputs.				
3	Set all inputs (Data, CLK, Enable, etc.) to a known state.	3	Remove V <sub>DD</sub> .				
4	Apply V <sub>BB</sub> .	4	Disconnect ground V <sub>SS</sub> .				

Note 1: The  $V_{BB}$  should not drop below  $V_{DD}$  or float during operation.

## FUNCTION TABLE<sup>1</sup>

Serial	Clock	S	hift R	egister Cont	ents	Serial	LE		Lat	ch Contents		Blanking	Output Contents				
Data Input	Input	I <sub>1</sub>	l <sub>2</sub>	I <sub>3</sub> I <sub>N-1</sub>	I <sub>N</sub>	Data Output	Strobe Input			Input	I <sub>1</sub>	l <sub>2</sub>	I <sub>3</sub> I <sub>N-1</sub>	I <sub>N</sub>			
Н	L to H	Н	R <sub>1</sub>	R <sub>2</sub> R <sub>N-2</sub>	R <sub>N-1</sub>	R <sub>N-1</sub>	—	I	_		_	—		—		—	
L	L to H	L	$R_1$	R <sub>2</sub> R <sub>N-2</sub>	R <sub>N-1</sub>	R <sub>N-1</sub>	—	I		—	_	—				—	
Х	H to L	$R_1$	$R_2$	R <sub>3</sub> R <sub>N-1</sub>	R <sub>N</sub>	R <sub>N</sub>	—	I				—				—	
		Х	Х	XX	Х	Х	L	$R_1$	$R_2$	R <sub>3</sub> R <sub>N-1</sub>	$R_N$	—	I	_		—	
—	—	$P_1$	P <sub>2</sub>	P <sub>3</sub> P <sub>N-1</sub>	P <sub>N</sub>	P <sub>N</sub>	Н	P <sub>1</sub>	$P_2$	P <sub>3</sub> P <sub>N-1</sub>	$P_N$	L	$P_1$	$P_2$	P <sub>3</sub> P <sub>N-1</sub>	$P_N$	
						_	_	Х	Х	XX	Х	Н	L	L	LL	L	

Note 1: L = Low logic level

H = High logic level

X = Don't care

P = Present state

R = Previous state

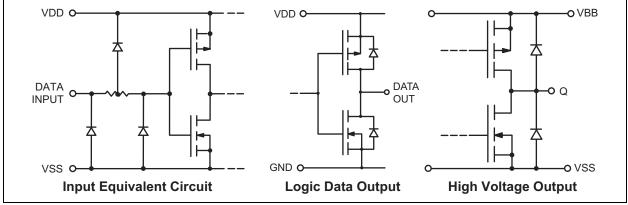


FIGURE 3-1:

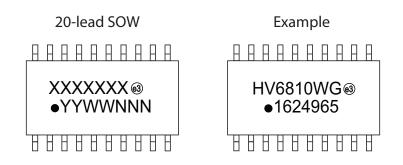
Input and Output Equivalent Circuits.

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# HV6810

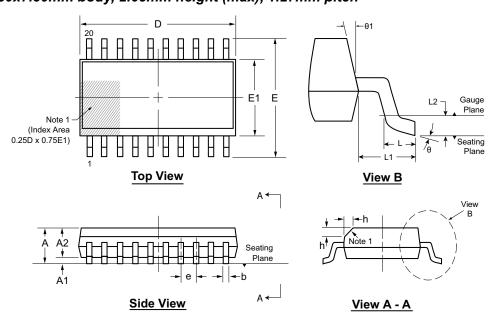
#### 4.0 PACKAGE MARKING INFORMATION

4.1 Packaging Information



Legend	4: XXX Y YY WW NNN @3 *	Product Code or Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC <sup>®</sup> designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
Note:	be carried	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for product code or customer-specific information. Package may or e the corporate logo.

#### 20-Lead SOW (Wide Body) Package Outline (WG) 12.80x7.50mm body, 2.65mm height (max), 1.27mm pitch



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Note:

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbo	bl	Α	A1	A2	b	D	E	E1	е	h	L	L1	L2	θ	θ1
	MIN	2.15*	0.10	2.05	0.31	12.60*	9.97*	7.40*		0.25	0.40			0°	5°
Dimension (mm)	NOM	-	-	-	-	12.80	10.30	7.50	1.27 BSC	-	-	1.40 REF	0.25 BSC	-	-
()	MAX	2.65	0.30	2.55*	0.51	13.00*	10.63*	7.60*		0.75	1.27			<b>8</b> 0	15°

JEDEC Registration MS-013, Variation AC, Issue E, Sep. 2005. \* This dimension is not specified in the JEDEC drawing.

Drawings are not to scale.

# HV6810

NOTES:

### APPENDIX A: REVISION HISTORY

#### **Revision A (October 2016)**

- Converted Supertex Doc# DSFP-HV6810 to Microchip DS20005626A
- Removed the PJ package option
- Changed the quantity of the WG package from 1000/Reel to 1600/Reel
- Made minor text changes throughout the document

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PART NO.	<u>xx</u>	-	· <u>x</u> - <u>x</u>	Example:	
Device	Package Options		Environmental Media Type	a) HV6810WG-G:	10-Channel Serial-Input Latched Dis- play Driver, 20-lead SOIC, 1600/Reel for a WG Package
Device:	HV6810	=	10-Channel Serial-Input Latched Display Driver		
Package:	WG	=	20-lead SOIC		
Environmental:	G	=	Lead (Pb)-free/RoHS-compliant Package		
Media Type:	(blank)	=	1600/Reel for a WG Package		
L					

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ISBN: 978-1-5224-1003-4



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